

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	30	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	V
Average Rectified Output Current (Note 5)	I <sub>O</sub>	200	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	1.0	A

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P <sub>D</sub>	150	mW
Typical Thermal Resistance, Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	450	°C/W
Typical Thermal Resistance, Junction to Ambient Air (Note 6)		240	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +125	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	30	—	—	V	I <sub>R</sub> = 150μA
Forward Voltage Drop	V <sub>F</sub>	—	—	0.15 0.20 0.35 0.50	V	I <sub>F</sub> = 100μA I <sub>F</sub> = 1mA I <sub>F</sub> = 20mA I <sub>F</sub> = 200mA
Leakage Current (Note 7)	I <sub>R</sub>	—	—	150 30	μA μA	V <sub>R</sub> = 30V V <sub>R</sub> = 10V
Total Capacitance	C <sub>T</sub>	—	20	—	pF	V <sub>R</sub> = 0V, f = 1.0MHz

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>  
6. Part mounted on 1-inch sq. 2oz copper pad.  
7. Short duration pulse test used to minimize self-heating effect.

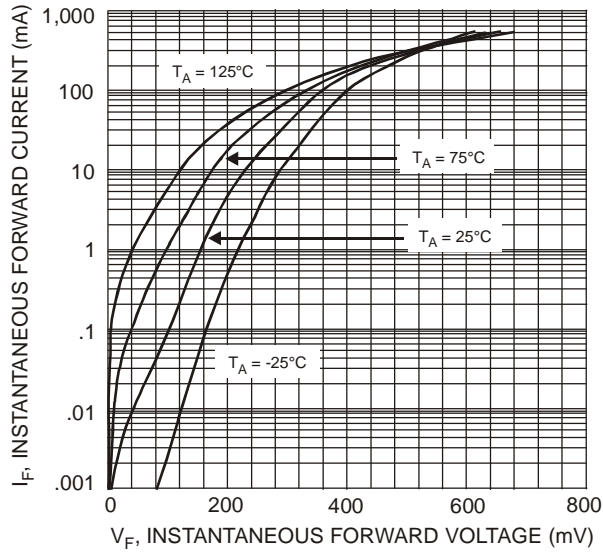


Fig. 1 Typical Forward Characteristics

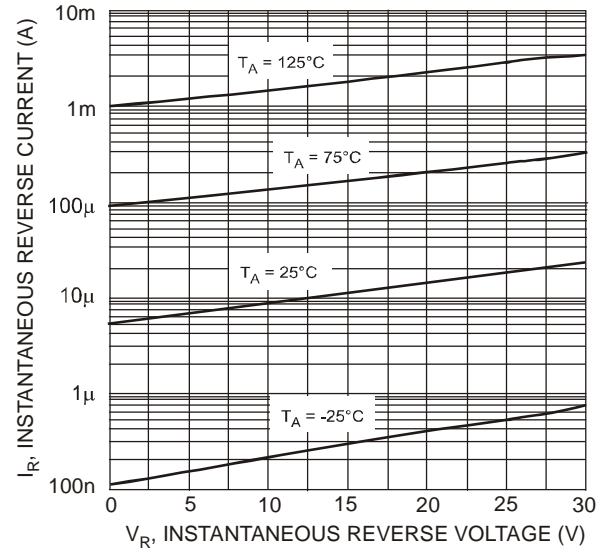


Fig. 2 Typical Reverse Characteristics

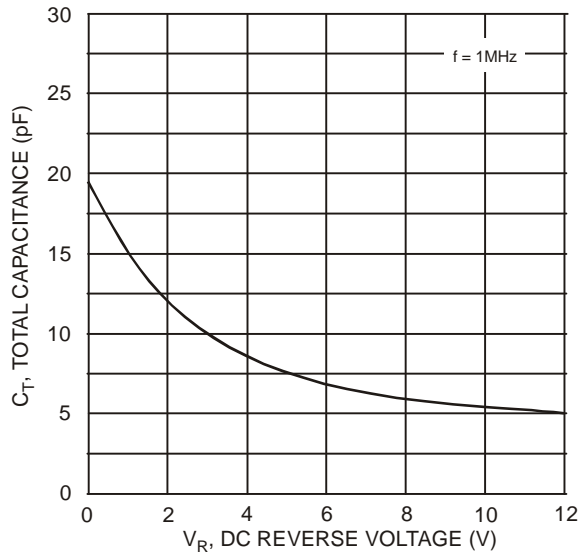


Fig. 3 Total Capacitance vs. Reverse Voltage

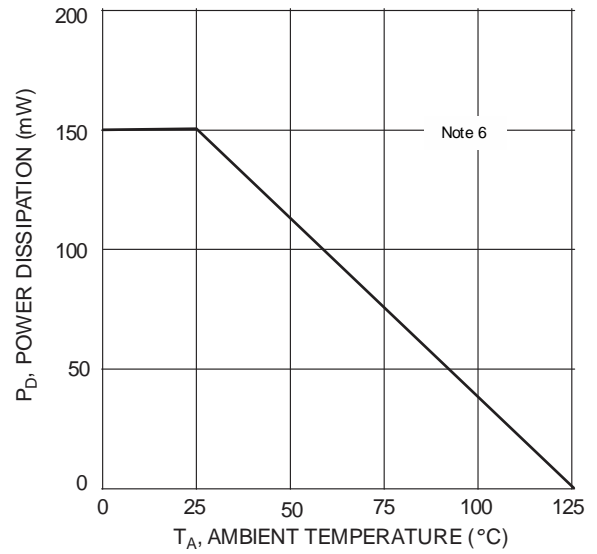
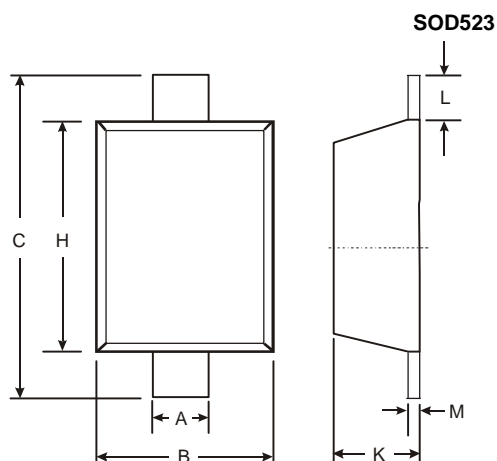


Fig. 4 Power Derating Curve

## Package Outline Dimensions

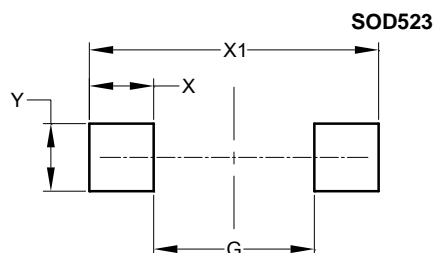
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOD523		
Dim	Min	Max
A	0.25	0.35
B	0.70	0.90
C	1.50	1.70
H	1.10	1.30
K	0.55	0.65
L	0.10	0.30
M	0.10	0.12
All Dimensions in mm		

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
G	0.80
X	0.60
X1	2.00
Y	0.70

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